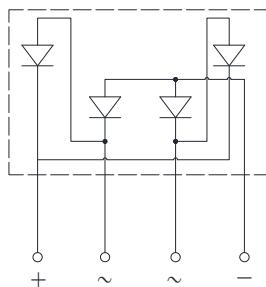
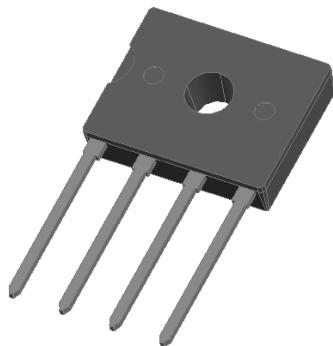


Low VF Bridge Rectifiers



Features

- UL recognition, file #E230084
- Glass passivated chip junction
- Low VF
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

Mechanical Data

- **Package:** D3K
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked on body

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	D4UBL80
Device marking code			D4UBL80
Maximum Repetitive Peak Reverse Voltage	VRRM	V	800
Maximum RMS Voltage	VRMS	V	560
Maximum DC blocking Voltage	VDC	V	800
Average rectified output current @60Hz sine wave, R-load	IO	A	4.0
With heatsink Tc =138°C			1.3
Without heatsink Ta =25°C			
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, Tj=25°C	IFSM	A	135
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C			270
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode	I ² t	A ² s	75.6
Storage temperature	Tstg	°C	-55 ~ +150
Junction temperature	Tj	°C	-55 ~ +150
Dielectric strength @ Terminals to case, AC 1 minute	Vdis	KV	2
Mounting torque @Recommend torque: 5kg·cm	Tor	kg·cm	8

**■ Electrical Characteristics (Ta=25°C Unless otherwise specified)**

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	D4UBL80
Maximum instantaneous forward voltage drop per diode	VF	V	IFM=2.0A	0.92
Maximum DC reverse current at rated DC blocking voltage per diode	IR	μA	T _j =25°C	5
			T _j =125°C	100
Typical junction capacitance	C _j	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	40

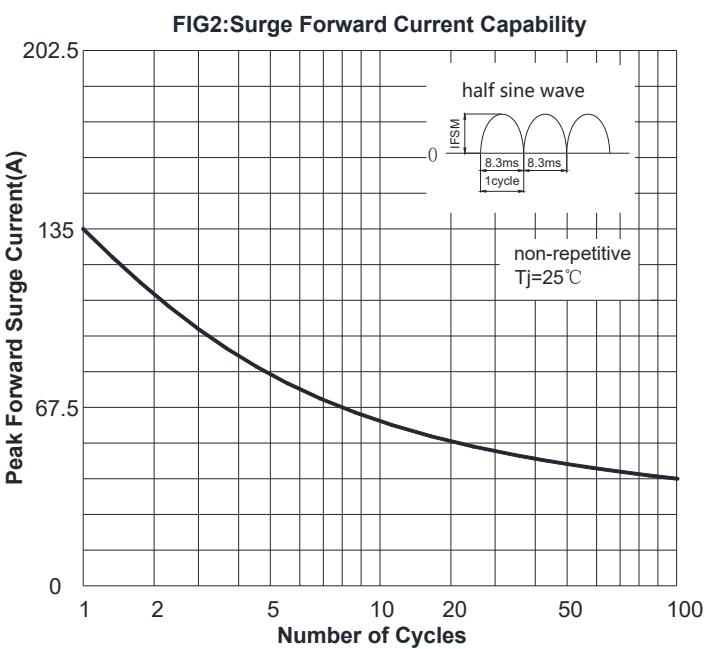
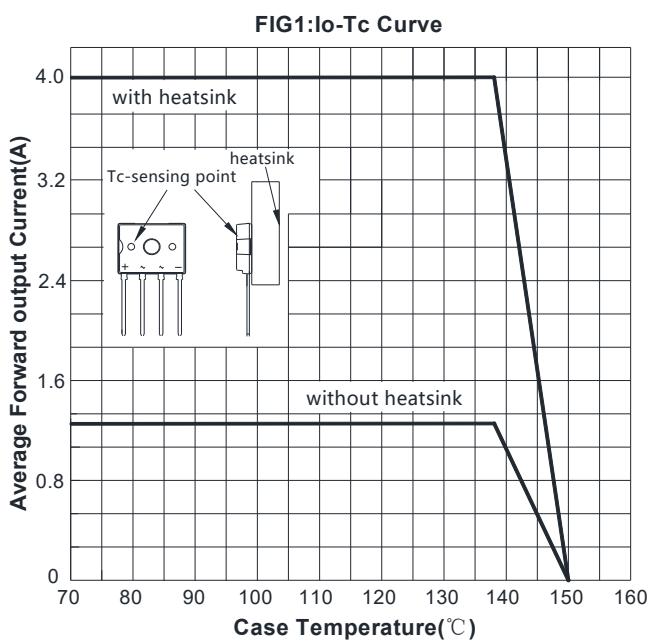
■ Thermal Characteristics (Ta=25°C Unless otherwise specified)

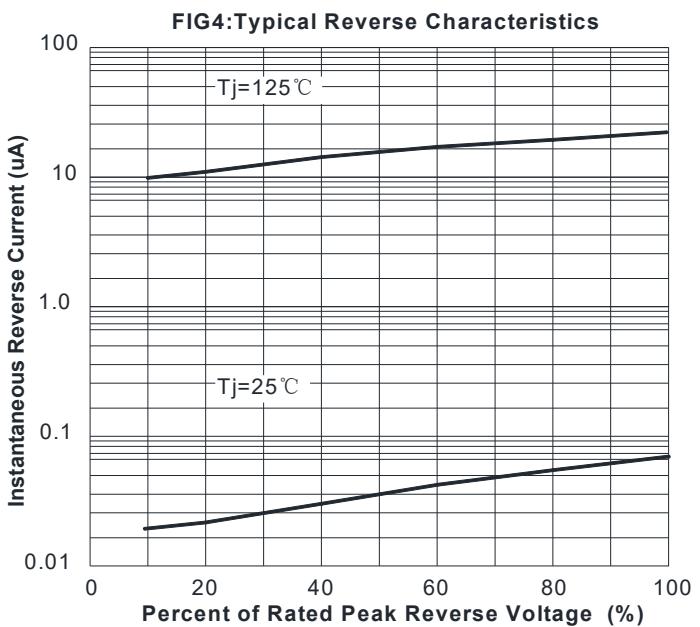
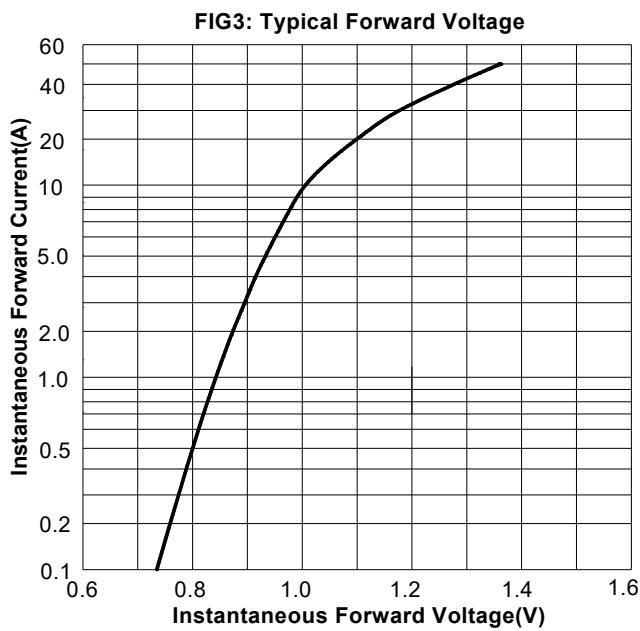
PARAMETER		SYMBOL	UNIT	D4UBL80
Thermal resistance	Between junction and ambient, Without heatsink	R _{θJ-A}	°C/W	55.0
	Between junction and case, With heatsink	R _{θJ-C}		1.5

Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

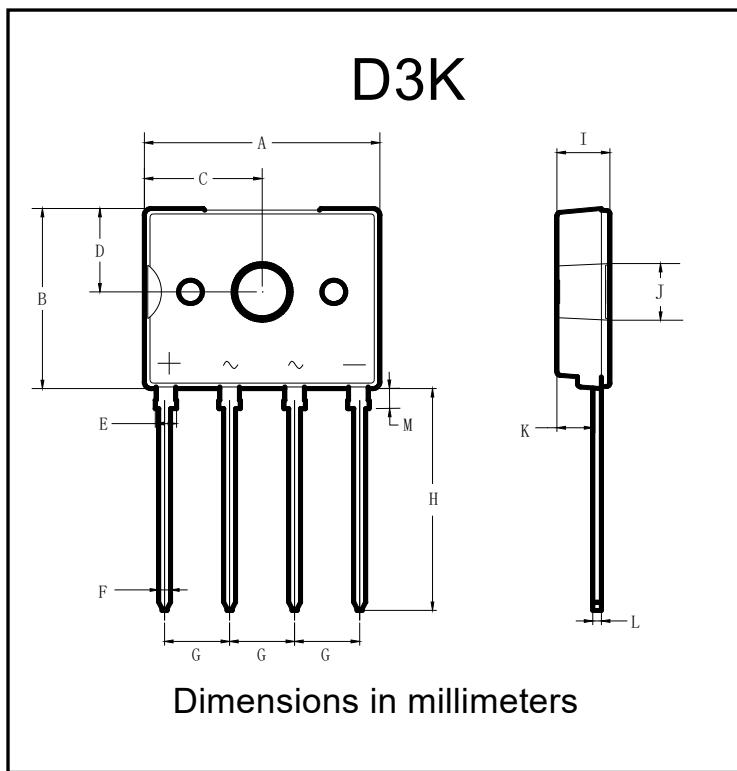
■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
D4UBL80	B1	Approximate 1.266	25	1500	6000	TUBE

■ Characteristics (Typical)



■ Outline Dimensions



D3K		
Dim	Min	Max
A	13.30	14.30
B	10.30	11.30
C	6.40	7.40
D	4.50	5.50
E	1.05	1.45
F	0.60	0.85
G	3.70	3.90
H	13.10	13.50
I	2.60	3.60
J	3.10	3.40
K	2.00	2.20
L	0.40	0.60
M	0.90	1.50



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